

FEATURES

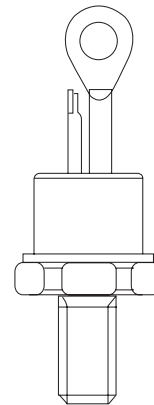
- 1). Improved glass passivation for high reliability and exceptional stability at high temperature
- 2). High di/dt and dv/dt capabilities
- 3). Standard package
- 4). Low thermal resistance
- 5). Metric threads version available
- 6). Types up to 1600V V_{DRM}/V_{RRM}

TYPICAL APPLICATIONS

- 1). Medium power switching
- 2). Phase control applications
- 3). Can be supplied to meet stringent military, aerospace and other high-reliability requirements

MAJOR RATINGS AND CHARACTERISTICS

Parameters		K16RIA		Unit
		10 to 120	140 to 160	
$I_{F(AV)}$		16	16	A
	@ T_C	85	85	°C
$I_{F(RMS)}$		35	35	A
I_{FSM}	@ 50Hz	340	225	A
	@ 60Hz	360	235	A
I^2t	@ 50Hz	574	255	A ² s
	@ 60Hz	524	235	A ² s
V_{DRM}/V_{RRM}		100 to 1200	1400 to 1600	V
T_q	typical	110		μs
T_J		- 65 to 125		°C



ELECTRICAL SPECIFICATIONS

1). Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , maximum repetitive peak reverse voltage *(1)	V_{RSM} , maximum non-repetitive peak reverse voltage *(2)	I_{DRM}/I_{RRM} max. @ $T_J = T_{J\ max}$
		V	V	mA
K16RIA	10	100	150	20
	20	200	300	10
	40	400	500	
	60	600	700	
	80	800	900	
	100	1000	1100	
	120	1200	1300	
	140	1400	1500	
	160	1600	1700	

*(1) Units may be broken over non-repetitively in the off-state direction without damage, if di/dt does not exceed 20A/μs

*(2) For voltage pulses with $t_p \leq 5ms$

2). Forward Conduction

Parameters		K16RIA		Unit	Conditions		
		10 to 120	140 to 160				
I _{T(AV)}	Max. average forward current	16	16	A	180° conduction, half sine wave		
	@ Case temperature	85	85	°C			
I _{T(RMS)}	Max. RMS forward current	35	35	A			
I _{TSM}	Max. peak, one-cycle forward, non-repetitive surge current	340	225	A	t = 10ms	No voltage	Sinusoidal half wave, Initial T _J = T _J max.
		360	235		t = 8.3ms	reapplied	
		285	190		t = 10ms	100% V _{RRM}	
		300	200		t = 8.3ms	reapplied	
I ² t	Maximum I ² t for fusing	574	255	A ² s	t = 10ms	No voltage	
		524	235		t = 8.3ms	reapplied	
		405	180		t = 10ms	100% V _{RRM}	
		375	165		t = 8.3ms	reapplied	
I ² √t	Maximum I ² √t for fusing	5740	2550	A ² √s	t = 0.1 to 10ms, no voltage reapplied		
V _{T(TO)1}	Low level value of threshold voltage	0.97	1.14	V	(16.7% × π × I _{F(AV)}) < I < π × I _{F(AV)} , T _J = T _J max.		
V _{T(TO)2}	High level value of threshold voltage	1.24	1.31	V	(I > π × I _{F(AV)}), T _J = T _J max.		
r _{t1}	Low level value of forward slope resistance	17.9	14.83	mΩ	(16.7% × π × I _{F(AV)}) < I < π × I _{F(AV)} , T _J = T _J max.		
r _{t2}	High level value of forward slope resistance	13.6	12.03	mΩ	(I > π × I _{F(AV)}), T _J = T _J max.		
V _{TM}	Max. forward voltage drop	1.75	-	V	I _{pk} = 50A, T _J = 25°C t _p = 10ms sine pulse		
		-	1.80				
I _H	Maximum holding current	130		mA	T _J = 25° C, anode supply 12V		
I _L	Typical latching current	200			resistive load		
di/dt	Max. rate of rise of turned-on current			A/μs	T _J = T _J max., V _{DM} = rated V _{DRM} Gate pulse = 20V, 15Ω, t _p = 6 μs, tr = 0.1 μs max. I _{TM} = (2x rated di/dt) A		
	V _{DRM} ≤ 600V	200					
	V _{DRM} ≤ 800V	180					
	V _{DRM} ≤ 1000V	160					
	V _{DRM} ≤ 1600V	150					
t _{gt}	Typical turn-on time	0.9			T _J = 25°C, at = rated V _{DRM} /V _{RRM} , T _J = 125°C		
t _{tr}	Typical reverse recovery time	4			T _J = T _J max., I _{TM} = I _{T(AV)} , t _p > 200 μs, di/dt = -10A/μs		
t _q	Typical turn-off time	110		μs	T _J = T _J max., I _{TM} = I _{T(AV)} , t _p > 200 μs, V _R = 100V, di/dt = -10A/μs, dv/dt = 20V/μs linear to 67% V _{DRM} , gate bias 0V-100W		
dv/dt	Max. critical rate of rise of	100		V/μs	T _J = T _J max. linear to 100% rated V _{DRM}		
	off-state voltage	300 (*)			T _J = T _J max. linear to 67% rated V _{DRM}		

(*) t_q = 10 μs up to 600V, t_q = 30 μs up to 1600V available on special request.

(**) Available with: dv/dt = 1000V/μs, to complete code add S90 i.e. K16RIA120S90.

3). Triggering

Parameters		K16RIA		Unit	Conditions	
P_{GM}	Maximum peak gate power	8.0		W	$T_J = T_J \text{ max.}$	
$P_{G(AV)}$	Maximum average gate power	2.0				
I_{GM}	Max. peak positive gate current	1.5		A	$T_J = T_J \text{ max.}$	
$-V_{GM}$	Maximum peak negative gate voltage	10		V	$T_J = T_J \text{ max.}$	
I_{GT}	DC gate current required to trigger	90		mA	$T_J = -65^\circ\text{C}$ Max. required gate trigger current/ voltage are the lowest value which will trigger all units 6V anode-to- cathode applied $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$	
		60				
		35				
V_{GT}	DC gate voltage required to trigger	3.0		V	$T_J = -65^\circ\text{C}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$	
		2.0				
		1.0				
I_{GD}	DC gate current not to trigger	2.0		mA	$T_J = T_J \text{ max.}, V_{DRM} = \text{rated value}$	
V_{GD}	DC gate voltage not to trigger	0.2		V	$T_J = T_J \text{ max.}$ Max. gate current/ voltage not to trigger is the max. value which. will not trigger any unit with rated V_{DRM} anode-to-cathode applied $V_{DRM} = \text{rated value}$	
T_J	Max. operating temperature range	- 65 to 125		$^\circ\text{C}$		
T_{stg}	Max. storage temperature range	- 65 to 125		$^\circ\text{C}$		
R_{thJC}	Max. thermal resistance, junction to case	0.86		K/W	DC operation	
R_{thCS}	Max. thermal resistance, case to heatsink	0.35		K/W	Mounting surface, smooth, flat and greased	
T	Mounting torque		to nut	to device	Lubricated threads (Non-lubricated threads)	
			20(27.5)	25		lbf-in
			0.23(0.32)	0.29		kgf.m
			2.3(3.1)	2.8		Nm
wt	Approximate weight	14 (0.49)		g (oz)	See Outline Table	
	Case style	TO-48				

ΔR_{thJC} Conduction

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.21	0.15	K/W	$T_J = T_J \text{ max.}$
120°	0.25	0.25		
90°	0.31	0.34		
60°	0.45	0.47		
30°	0.76	0.76		

PERFORMANCE CURVES FIGURE

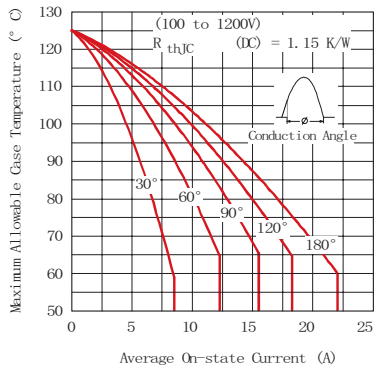


Fig. 1 - Current Ratings Characteristic

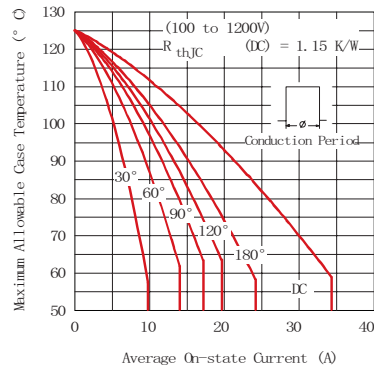


Fig. 2 - Current Ratings Characteristic

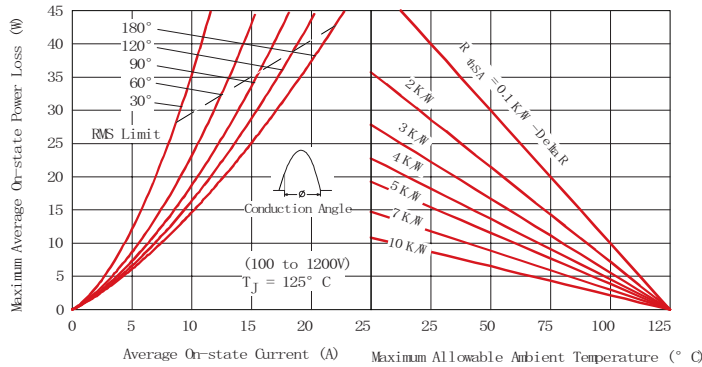


Fig. 3 - On-state Power Loss Characteristics

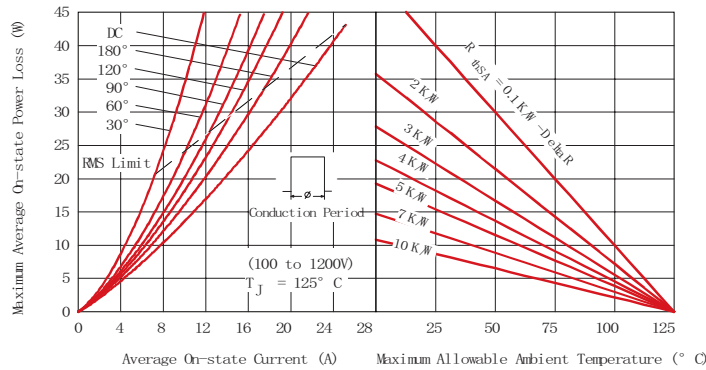
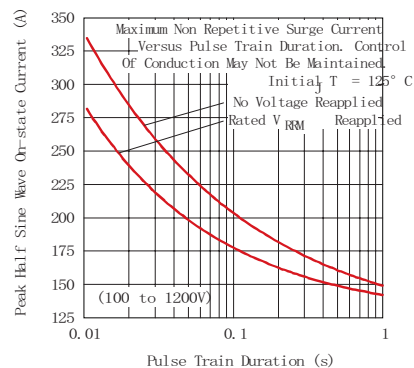
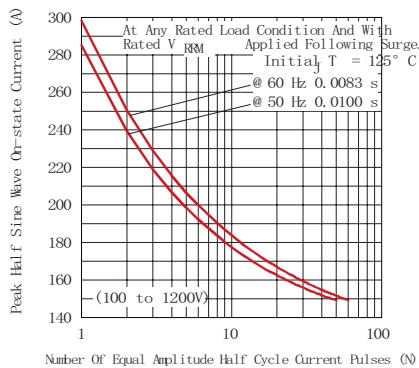


Fig. 4 - On-state Power Loss Characteristics



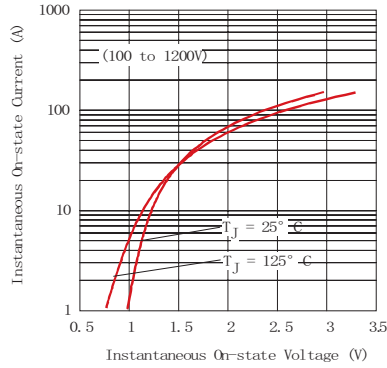


Fig. 7 - Forward Voltage Drop Characteristics

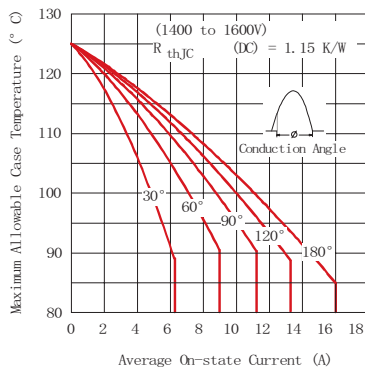


Fig. 8 - Current Ratings Characteristics

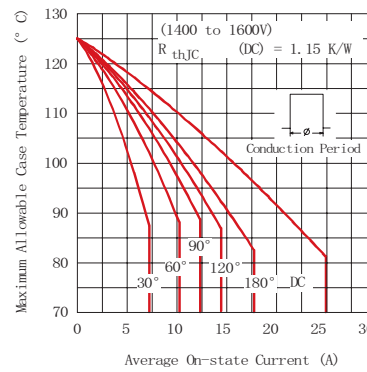


Fig. 9 - Current Ratings Characteristics

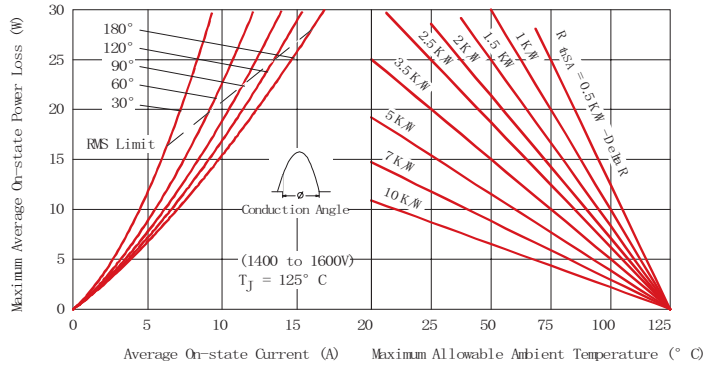


Fig. 10 - On-state Power Loss Characteristics

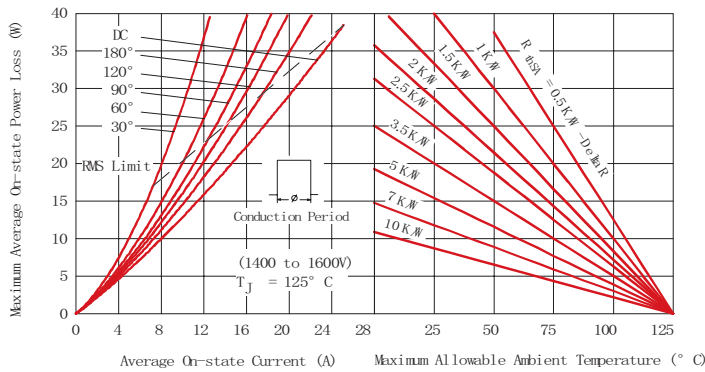


Fig. 11 - On-state Power Loss Characteristics

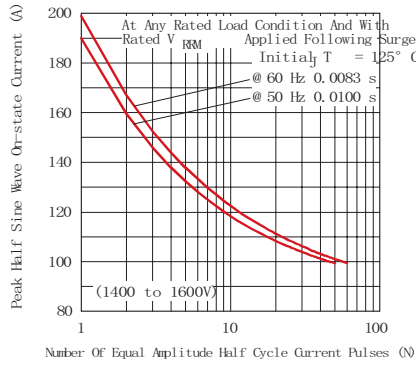


Fig. 12 - Maximum Non-Repetitive Surge Current

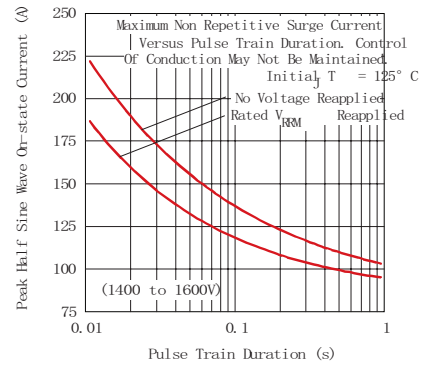


Fig. 13 - Maximum Non-Repetitive Surge Current

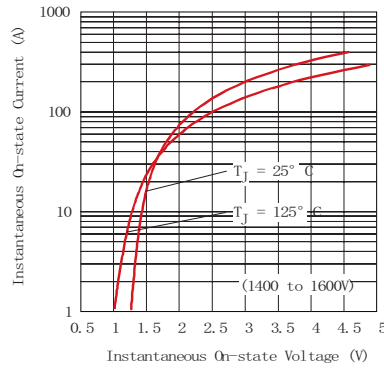


Fig. 14 - Forward Voltage Drop Characteristics

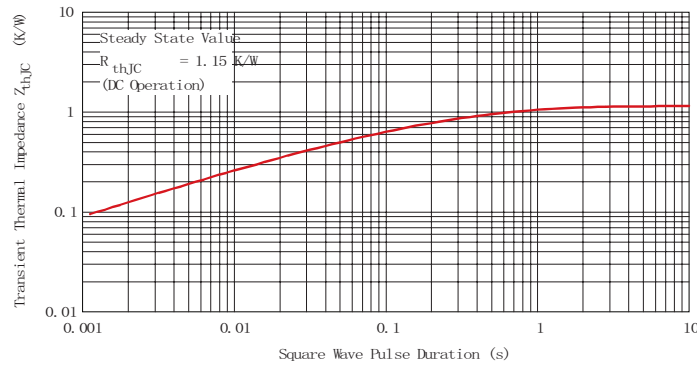


Fig. 15 - Thermal Impedance Z_{thJC} Characteristics

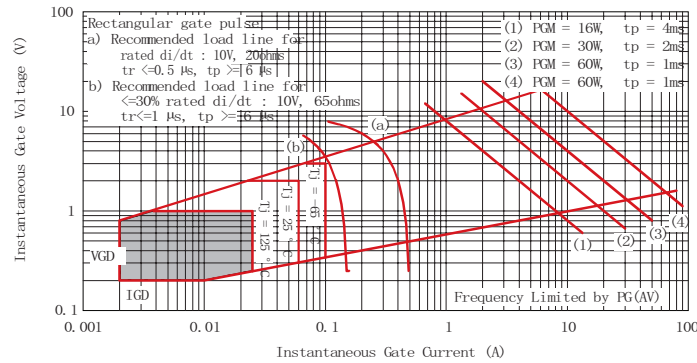
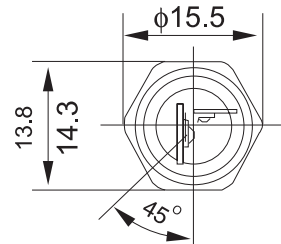
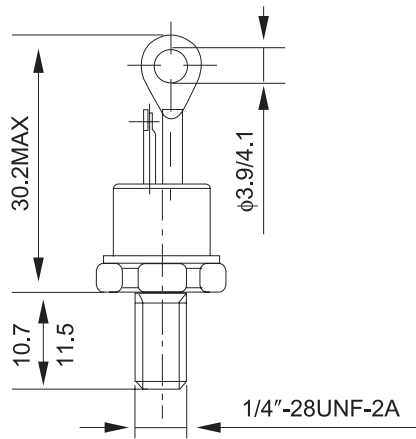


Fig. 16 - Gate Characteristics

OUTLINE



*FOR METRIC DEVICE:M6×1

Case Style TO-48

YUEQING LIUJING RECTIFIER CO., LTD

Sale Department: Liujing Building, Yueqing City,
Zhejiang Province

Add: Wanao Industrial Zone, Yueqing city,
Zhejiang Province

Tel: 0086-577-62519692 0089-577-62519693

Fax: 0086-577-62518692

International Export: 0086-577-62571902

Technical Support: 0086-15868768965

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